

Fast Avalanche SMD Rectifier


DO-214AC (SMA)

| PRIMARY CHARACTERISTICS | |
|-------------------------|----------------|
| $I_{F(AV)}$ | 1.5 A |
| V_{RRM} | 800 V, 1000 V |
| I_{FSM} | 30 A |
| I_R | 1.0 μ A |
| V_F | 1.6 V |
| t_{rr} | 120 ns |
| E_R | 20 mJ |
| T_J max. | 150 °C |
| Package | DO-214AC (SMA) |
| Diode variation | Single die |

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Low reverse current
- Soft recovery characteristic
- Fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

TYPICAL APPLICATIONS

For use in fast switching rectification of power supply, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS-compliant, commercial grade

Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

| MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted) | | | | |
|--|----------------|-------------|--------|------|
| PARAMETER | SYMBOL | BYG21K | BYG21M | UNIT |
| Device marking code | | BYG21K | BYG21M | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 800 | 1000 | V |
| Average forward current | $I_{F(AV)}$ | 1.5 | | A |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I_{FSM} | 30 | | A |
| Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1\text{ A}$, $T_J = 25\text{ °C}$ | E_R | 20 | | mJ |
| Operating junction and storage temperature range | T_J, T_{STG} | -55 to +150 | | °C |



| ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | |
|--|---|-----------------------------------|-------------|--------|---------------|
| PARAMETER | TEST CONDITIONS | SYMBOL | BYG21K | BYG21M | UNIT |
| Maximum instantaneous forward voltage | $I_F = 1\text{ A}$ | $T_J = 25\text{ }^\circ\text{C}$ | $V_F^{(1)}$ | 1.5 | V |
| | $I_F = 1.5\text{ A}$ | | | 1.6 | |
| Maximum reverse current | $V_R = V_{RRM}$ | $T_J = 25\text{ }^\circ\text{C}$ | I_R | 1 | μA |
| | | $T_J = 100\text{ }^\circ\text{C}$ | | 10 | |
| Maximum reverse recovery time | $I_F = 0.5\text{ A}$, $I_R = 1.0\text{ A}$, $I_{rr} = 0.25\text{ A}$ | t_{rr} | 120 | | ns |

Note

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | |
|---|-----------------------|--------|--------|--------------------|
| PARAMETER | SYMBOL | BYG21K | BYG21M | UNIT |
| Typical thermal resistance, junction to lead, $T_L = \text{const.}$ | $R_{\theta JL}$ | 25 | | $^\circ\text{C/W}$ |
| Typical thermal resistance, junction to ambient | $R_{\theta JA}^{(1)}$ | 150 | | $^\circ\text{C/W}$ |
| | $R_{\theta JA}^{(2)}$ | 125 | | |
| | $R_{\theta JA}^{(3)}$ | 100 | | |

Notes

- (1) Mounted on epoxy-glass hard tissue
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- (3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 μm Cu

| ORDERING INFORMATION (Example) | | | | |
|---------------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| BYG21K-E3/TR | 0.064 | TR | 1800 | 7" diameter plastic tape and reel |
| BYG21K-E3/TR3 | 0.064 | TR3 | 7500 | 13" diameter plastic tape and reel |
| BYG21KHE3/TR (1) | 0.064 | TR | 1800 | 7" diameter plastic tape and reel |
| BYG21KHE3/TR3 (1) | 0.064 | TR3 | 7500 | 13" diameter plastic tape and reel |

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

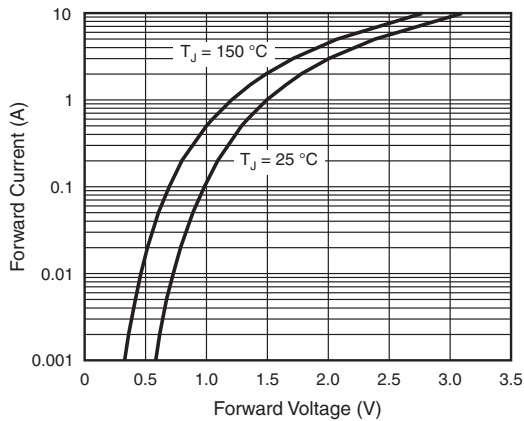


Fig. 1 - Forward Current vs. Forward Voltage

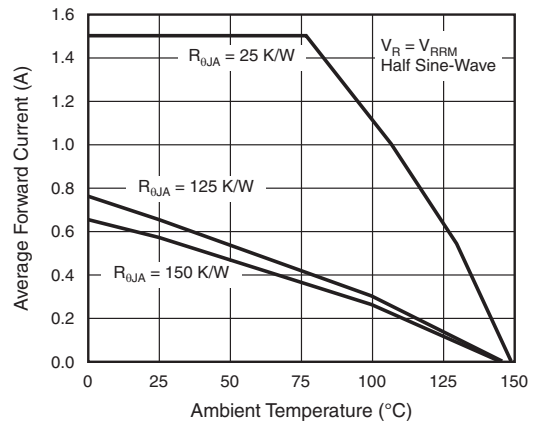


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

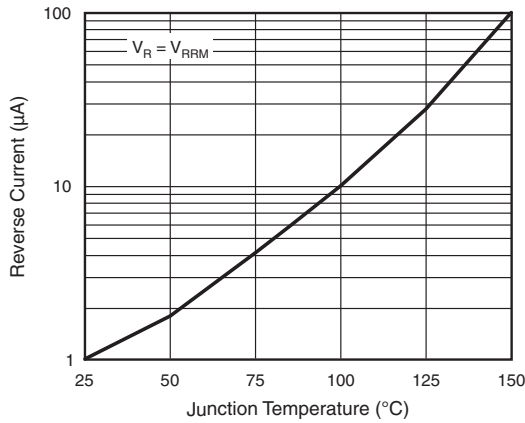


Fig. 3 - Reverse Current vs. Junction Temperature

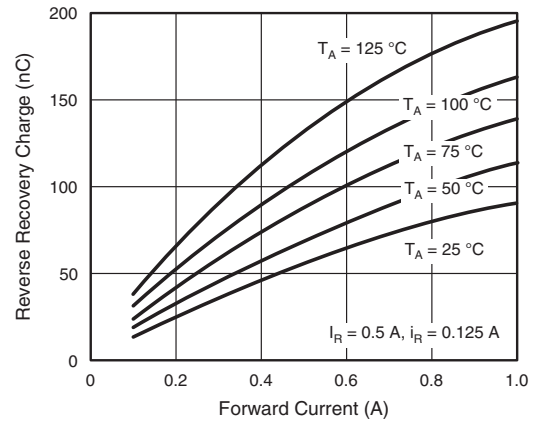


Fig. 6 - Max. Reverse Recovery Charge vs. Forward Current

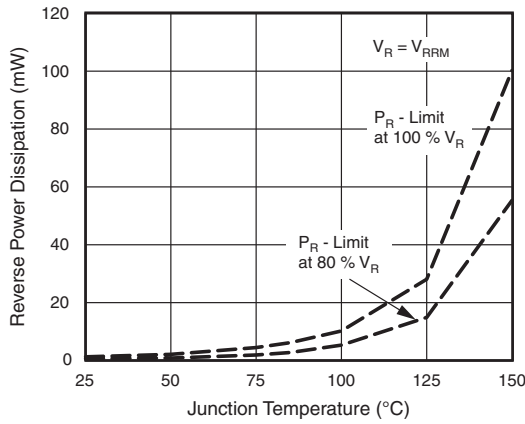


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

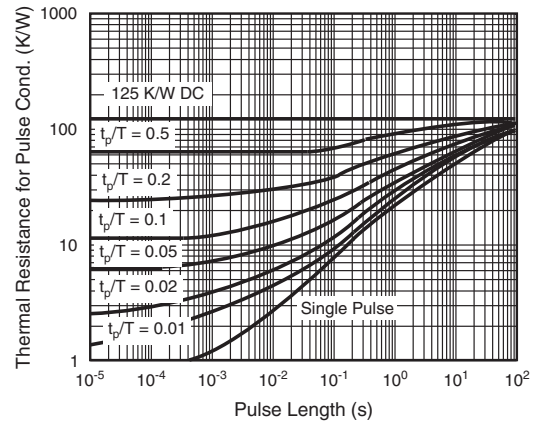


Fig. 7 - Thermal Response

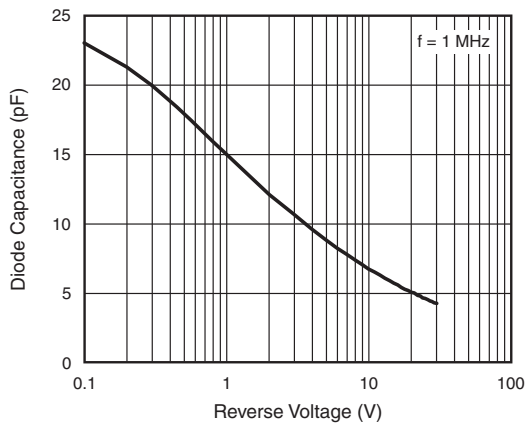
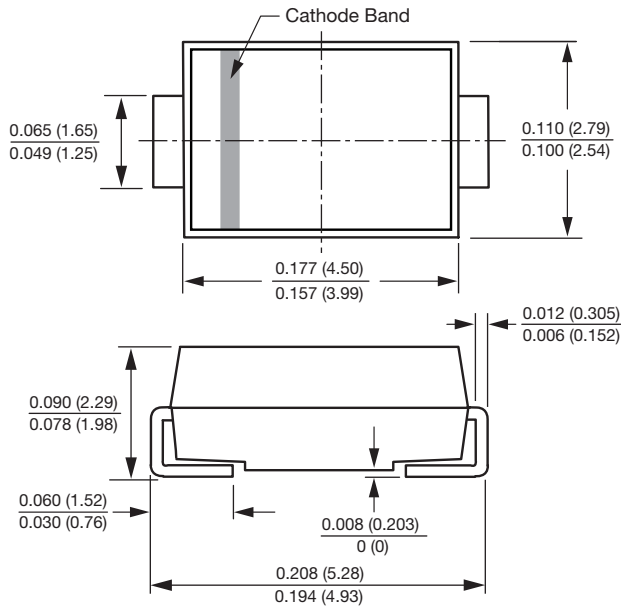


Fig. 5 - Diode Capacitance vs. Reverse Voltage

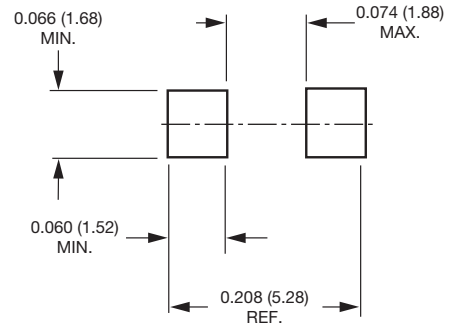


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





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